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Our Docket No.: M4065.0184/P184-A  
Micron Docket No.: 99-0132/US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
Alan G. Wood et al.

Serial No.: 09/930,295

Group Art Unit: 2815

Filed: August 16, 2001

Examiner: C. Chu

For: SEMICONDUCTOR DEVICE  
PACKAGE AND METHOD

AMENDMENT

**Box Non-Fee Amendment**  
Commissioner for Patents  
Washington, DC 20231

RECEIVED  
MAR 20 2002  
TECHNOLOGY CENTER 2800

Dear Sir:

In response to the Office Action dated December 14, 2001 (Paper No.4),  
please amend the above-identified U.S. Patent application as follows:

In the Specification:

Please replace the respective paragraphs of the specification with the amended  
paragraphs below:

Page 5, the paragraph beginning at line 20 through line 28:

Referring now to the drawings, where like reference numerals designate like  
elements, there is shown in FIG. 1 a semiconductor device package 10 constructed in

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